

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
Stylesheet Version v1.2

EPAS ID: PAT4165018

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
GI-YOUNG JEUN	09/29/2000
O-SEOB JEUN	09/29/2000
EUN-HO LEE	09/29/2000
SEUNG-WON LIM	09/29/2000
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<b>City:</b>	KYUNGKI-DO
<b>State/Country:</b>	KOREA, REPUBLIC OF
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	11327073
<b>CORRESPONDENCE DATA</b>	
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<b>NAME OF SUBMITTER:</b>	CHRISTINE HILLS
<b>SIGNATURE:</b>	/Christine Hills/
<b>DATE SIGNED:</b>	12/01/2016
<b>Total Attachments: 1</b>	
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ASSIGNMENT

DOCKET NO. 29347/990488

AS A BELOW NAMED INVENTOR, I, and each of us, individually hereby declare that: IN CONSIDERATION of the sum of TEN (\$10.00) dollars or the equivalent thereof, and other good and valuable consideration, the receipt of which from the hereinafter named Assignee is hereby acknowledged, I do hereby sell, assign and forever grant and convey unto:

ASSIGNEE: FAIRCHILD KOREA SEMICONDUCTOR LTD., a corporation organized under the laws of the Republic of Korea, ADDRESS: 82-3, Dodang-dong Wonmi-ku, Bucheon-city, Kyungki-do, Korea

Who is my Assignee, and to the successors and assigns of my Assignee, all my right, title and interest, in and for the United States of America and all other countries, including all rights of priority, in and to the invention entitled:

TITLE: SEMICONDUCTOR POWER MODULE HAVING AN ELECTRICALLY INSULATING HEAT SINK AND METHOD OF MANUFACTURING THE SAME

invented by me (if only one inventor is named below) or us (if more than one inventor is named below) and described in an application for a United States patent the specification of which is either attached hereto or otherwise accompanies this Assignment, or is more particularly identified as:

- executed on even date herewith, or
Serial No. 09/677,558 filed in the U.S. Patent & Trademark Office on 9/29/00 or
executed on 9/29/00

and in and to all United States patents which may be granted thereon and therefore, and in and to all certificates of corrections, divisions, continuations, continuations-in-part, reissued and re-examined patents, and to any extensions thereof, said interest being the entire ownership of the patent when granted, to be held and enjoyed by said FAIRCHILD KOREA SEMICONDUCTOR LTD., my Assignee, its successors, assigns or other legal representatives, to the full end of the term, terms, or any extension or renewal thereof, for which said patent or patents may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment, sale and conveyance had not been made:

AND I hereby covenant and agree to sign and execute, without receiving any money or other consideration, any further documents or instruments which may from time-to-time be either necessary, lawful, proper or requested by the Assignee, in the prosecution of the above-named application or in the preparation and prosecution of all substitute applications, certificate of correction, division, continuation, continuation-in-part, reissue, re-examination, in any amendment, extension, or interference proceeding, whether administrative or judicial, or otherwise, to secure the title hereto in said Assignee, together with the right of priority under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreement or treaty to which the United States of America adheres:

AND I do hereby authorize and request the Commissioner of Patent & Trademarks to issue said Patent or Patents to the Assignee, and I hereby appoint as my, or our attorney, and authorize and request Edward M. O'Toole, Reg. No. 22,477, to insert on this Assignment any further identification or to complete such identification which may be either necessary or desirable in order to comply the rules of the United States Patent & Trademark Office for recordation of this document.

IN WITNESS WHEREOF, I and we have set our hands and seals on the dates written beside my and our respective names:

- 1) Jeun, Gi-Young (Seal) September 29, 2000 Kim-Jung-Suk
2) Jeun O-Seob (Seal) September 29, 2000 Park-mi-hyang
3) Jeun, O-Seob (Seal) September 29, 2000 Lim, Ki-Sung
4) LEE, Eun-Ho (Seal) September 29, 2000 Park, Jung-ku
5) (Seal)